

MOSFET

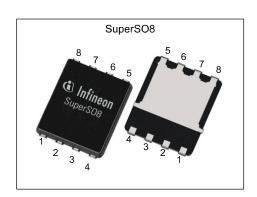
OptiMOS[™] Power-Transistor, 60 V

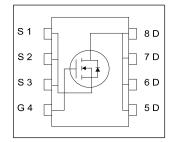
Features

- Optimized for high performance SMPS, e.g. sync. rec.
- 100% avalanche testedSuperior thermal resistance
- N-channel
- Qualified according to JEDEC¹⁾ for target applications
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
$V_{ t DS}$	60	V
R _{DS(on),max}	3.9	mΩ
I _D	102	Α
Q _{OSS}	32	nC
Q _G (0V10V)	27	nC











Type / Ordering Code	Package	Marking	Related Links
BSC039N06NS	PG-TDSON-8	039N06NS	-



Rev. 2.5, 2020-06-23

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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

-			Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	102 65 19	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50K/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	408	Α	T _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	50	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	69 2.5	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 K/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

2 Thermal characteristics

Table 3 **Thermal characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
raiametei	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R_{thJC}	-	1.1	1.8	K/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	K/W	-
Device on PCB, 6 cm ² cooling area ²⁾	R _{thJA}	_	_	50	K/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher case temperature please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 x 40 x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information
4) See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Damamatan	Coursels al		Values			N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.1	2.8	3.3	V	$V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =36 μ A
Zero gate voltage drain current	I _{DSS}	-	0.5 10	1 100	μA	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	3.3 4.8	3.9 5.9	mΩ	V _{GS} =10 V, I _D =50 A V _{GS} =6 V, I _D =12.5 A
Gate resistance ¹⁾	R _G	-	1.6	2.4	Ω	-
Transconductance	g_{fs}	42	85	-	S	V _{DS} >2 I _D R _{DS(on)max} , I _D =50 A

 Table 5
 Dynamic characteristics

Davamatar	Symbol	Values			11:4	Note / Test Condition
Parameter	Symbol		Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	2000	2500	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	490	613	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	22	44	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	12	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext},{\rm ext}$ =3 Ω
Rise time	t _r	-	12	-	ns	V_{DD} =30 V, V_{GS} =10 V, I_{D} =50 A, $R_{\text{G,ext}}$,ext=3 Ω
Turn-off delay time	$t_{ m d(off)}$	_	20	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$,ext=3 Ω
Fall time	t _f	_	7	-	ns	V_{DD} =30 V, V_{GS} =10 V, I_{D} =50 A, $R_{\text{G,ext}}$,ext=3 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Sumb al	Values			11	Note / Tost Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	9	-	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	5	-	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q_{gd}	-	5	7	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V
Switching charge	Q _{sw}	-	9	-	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate charge total ¹⁾	Q_g	-	27	32	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.8	-	V	V _{DD} =30 V, I _D =50 A, V _{GS} =0 to 10 V
Gate charge total, sync. FET	$Q_{g(sync)}$	-	24	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	32	40	nC	V _{DD} =30 V, V _{GS} =0 V

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition



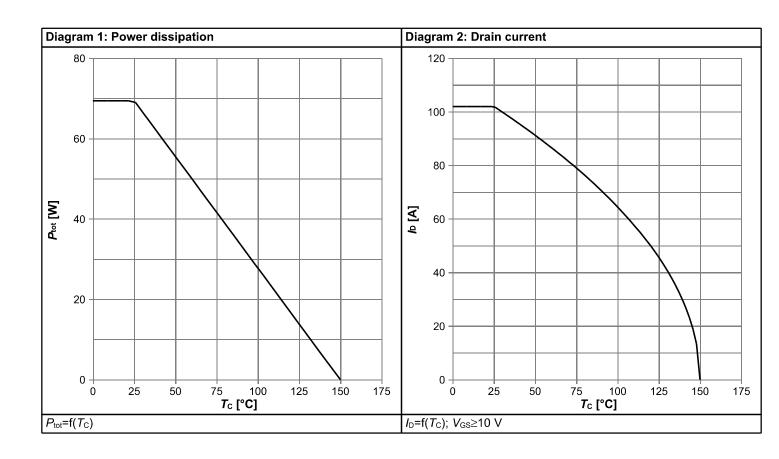
Table 7 Reverse diode

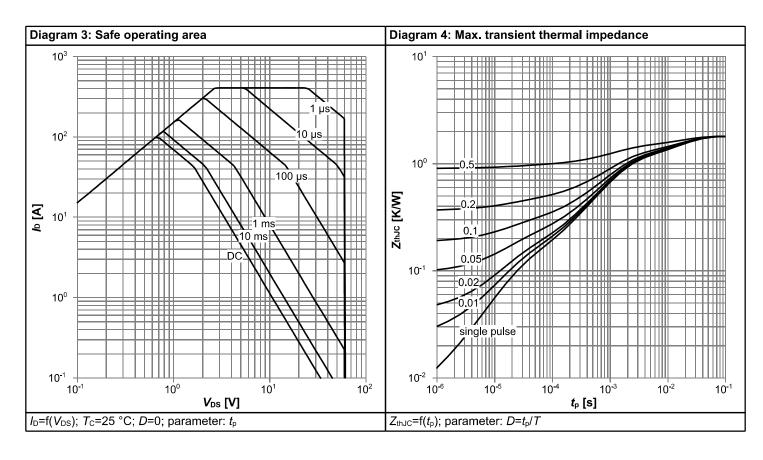
Parameter	Cymbal	Values			11	Nata / Tast Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	102	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	408	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.9	1.2	V	V _{GS} =0 V, I _F =50 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	32	51	ns	V _R =30 V, I _F =50 A, di _F /dt=100 A/μs
Reverse recovery charge	Q _{rr}	-	28	-	nC	V _R =30 V, I _F =50 A, di _F /dt=100 A/μs

5

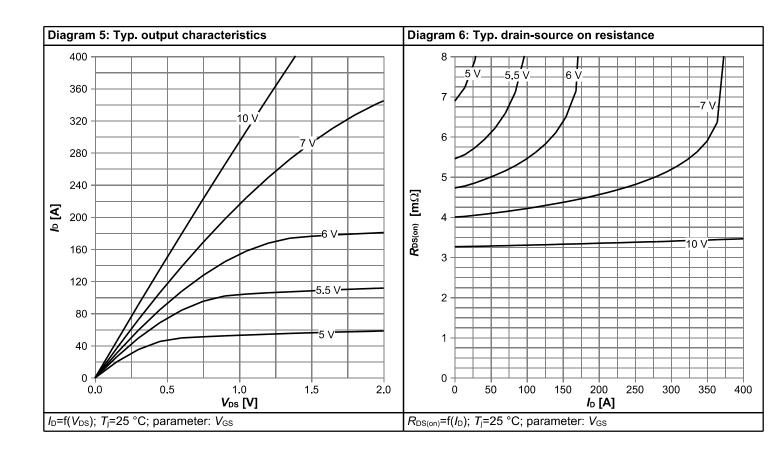


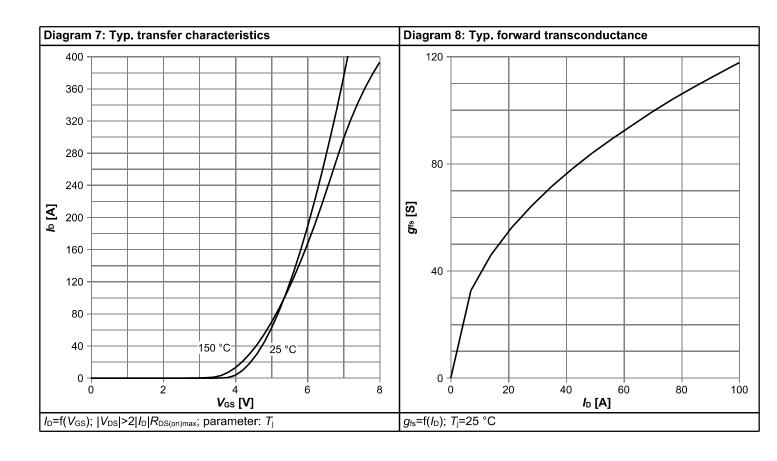
4 Electrical characteristics diagrams



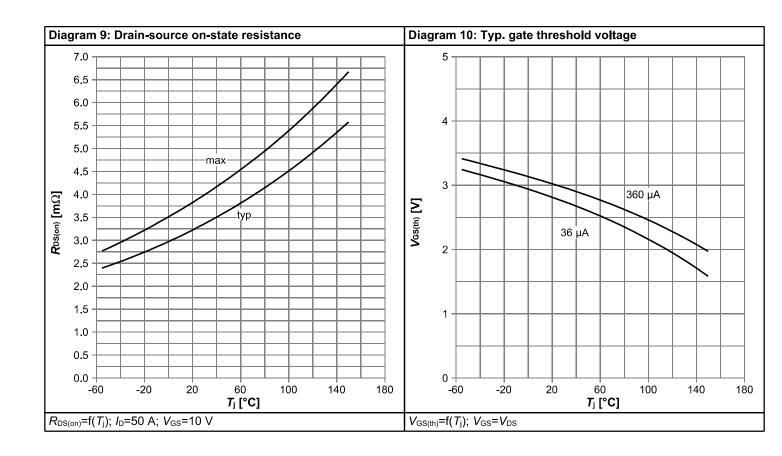


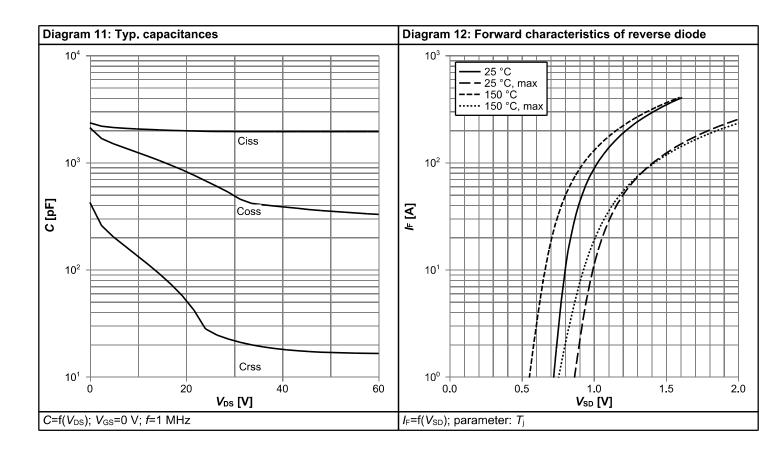




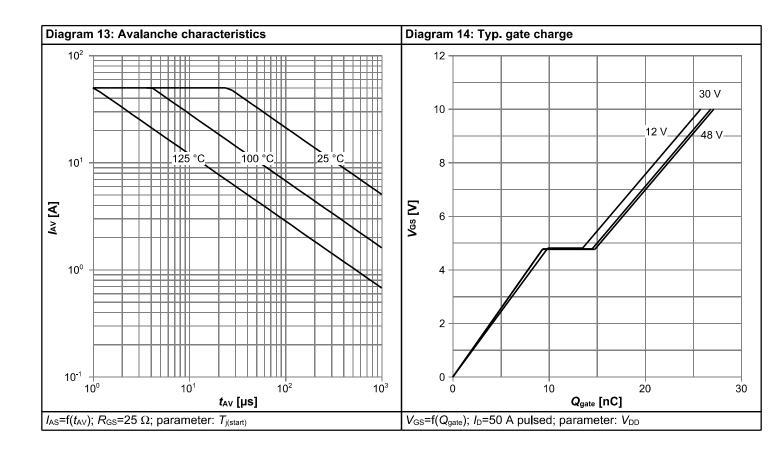


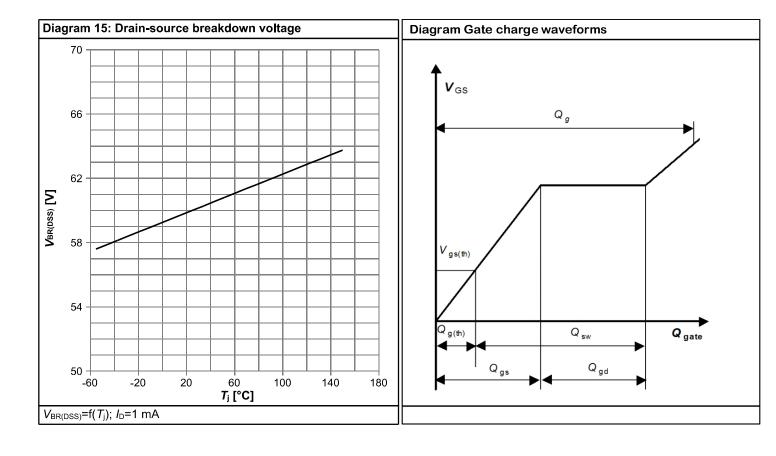






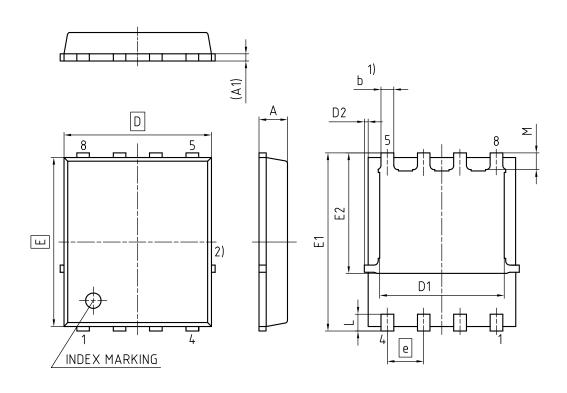








5 Package Outlines



1) EXCLUDING MOLD FLASH
2) REMOVAL ON MOLD GATE
INTRUSION 0.1 MM
PROTRUSION 0.1 MM
LEAD LENGTH UP TO ANTI FLASH LINE
ALL METAL SURFACES ARE PLATED, EXCEPT AREA OF CUT

DIMENSION	MILLIM	ETERS				
DIMENSION	MIN.	MAX.				
Α	0.90	1.20				
A1	0.15	0.35				
b	0.34	0.54				
D	4.80	5.35				
D1	3.90	4.40				
D2	0.03	0.23				
E	5.70	6.10				
E1	5.90	6.42				
E2	3.88	4.31				
е	1.27					
L	0.45	0.71				
М	0.45	0.69				

DOCUMENT NO. Z8B00003332				
		SION 7		
	SCALE	10:1		
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Figure 1 Outline PG-TDSON-8, dimensions in mm



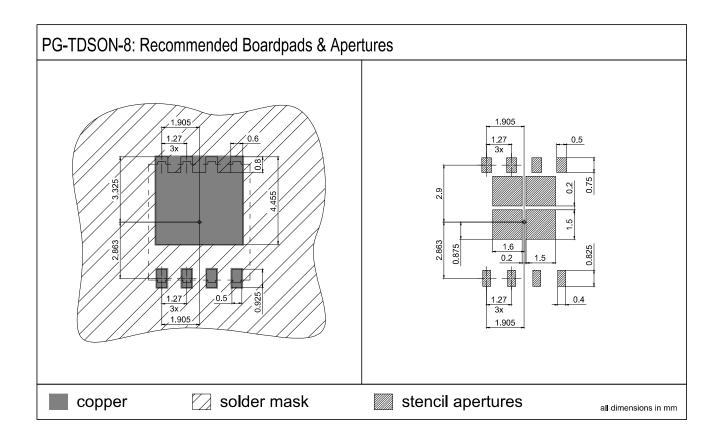
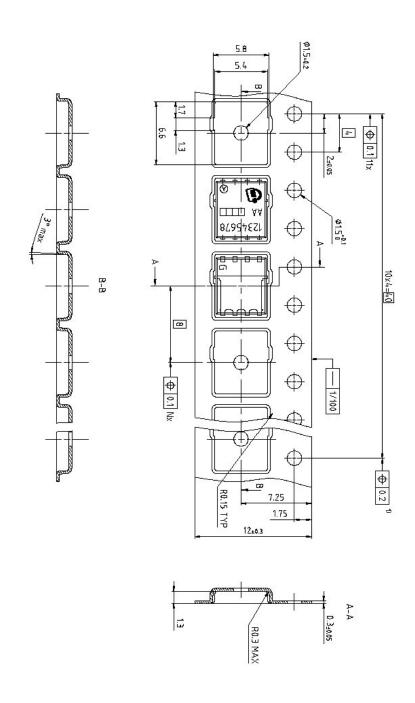


Figure 2 Outline Boardpads (TDSON-8), dimensions in mm





Dimension in mm

Figure 3 Outline Tape (TDSON-8)

OptiMOS $^{\text{TM}}$ Power-Transistor , 60 V BSC039N06NS



Revision History

BSC039N06NS

Revision: 2020-06-23, Rev. 2.5

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.3	2014-06-27	Rev.2.3
2.4	2020-02-03	Update package drawings,add RthJC bottom typ, add footnote for Rg, Capacitances, Gate charges (add Qoss max), trr and Qrr
2.5	2020-06-23	Update current rating

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